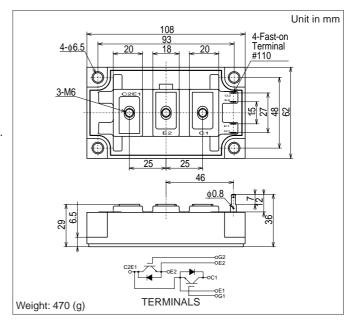
# MBM400JS6AW

Silicon N-channel IGBT

#### **OUTLINE DRAWING**

#### **FEATURES**

- \* High speed and low saturation voltage.
- \* low noise due to built-in free-wheeling diode ultra soft fast recovery diode(USFD).
- \* Isolated head sink (terminal to base).



ABSOLUTE MAXIMUM RATINGS (Tc=25°C)

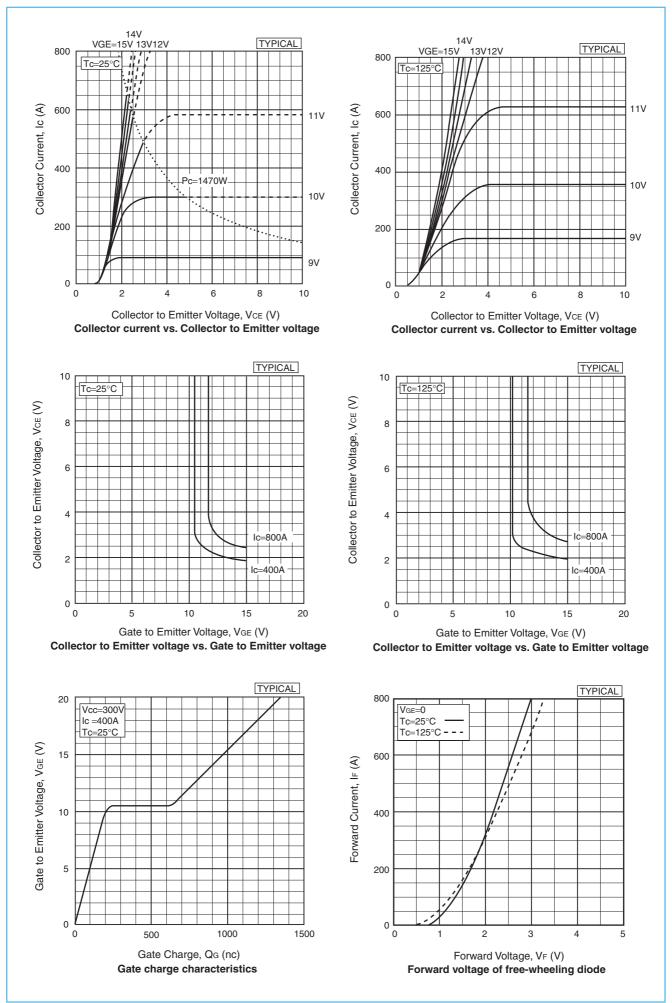
Item		Symbol	Unit	MBM400JS6AW		
Collector Emitter Voltag	Vces	V	600			
Gate Emitter Voltage	$V_{GES}$	V	±20			
Collector Current	DC	Ic	Α	400		
	1ms	I <sub>Cp</sub>	A	800		
Forward Current	DC	lF	А	400 (1)		
	1ms	I <sub>FM</sub>	A	800		
Collector Power Dissipat	Pc	W	1,470			
Junction Temperature	Tj	°C	-40 ~ +150			
Storage Temperature	T <sub>stg</sub>	°C	-40 ~ +125			
Isolation Voltage	V <sub>ISO</sub>	V <sub>RMS</sub>	2,500(AC 1 minute)			
Screw Torque Te	rminals	-	N.m	2.94(30) (2)		
Mo	unting	-	(kgf.cm)	2.94(30) (3)		

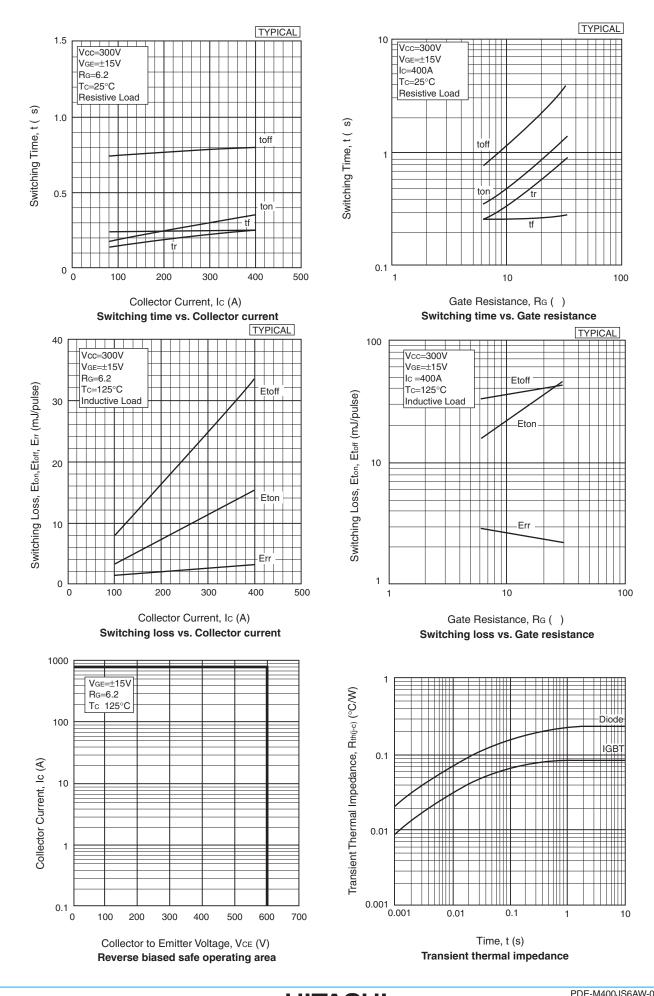
Notes:(1)RMS Current of Diode 120Arms max. (2)(3)Recommended Value 2.45N.m(25kgf.cm)

### CHARACTERISTICS (Tc=25°C)

Item		Symbol	Units	Min.	Тур.	Max.	Test Conditions
Collector Emitter Cut-Off Current		I <sub>CES</sub>	mA	-	-	1.0	$V_{CE}=600V, V_{GE}=0V$
Gate Emitter Leakage Current		I <sub>GES</sub>	nA	-	-	±500	V <sub>GE</sub> =±20V,V <sub>CE</sub> =0V
Collector Emitter Saturation Voltage		V <sub>CE(sat)</sub>	V	-	1.9	2.4	I <sub>C</sub> =400A,V <sub>GE</sub> =15V
Gate Emitter Threshold Voltage		V <sub>GE(TO)</sub>	V	-	-	10	V <sub>CE</sub> =5V, I <sub>C</sub> =400mA
Input Capacitance		Cies	pF	-	24,000	-	V <sub>CE</sub> =10V,V <sub>GE</sub> =0V,f=1MHz
Switching Times	Rise Time	tr		-	0.25	0.5	V <sub>CC</sub> =300V
	Turn On Time	ton	μS	-	0.35	0.7	$R_L=0.75\Omega$
	Fall Time	t <sub>f</sub>		-	0.25	0.35	$R_G=6.2\Omega \tag{4}$
	Turn Off Time	t <sub>off</sub>		-	0.8	1.1	V <sub>GE</sub> =±15V
Peak Forward Voltage Drop		V <sub>FM</sub>	V	-	2.2	3.0	I <sub>F</sub> =400A,V <sub>GE</sub> =0V
Reverse Recovery Time		trr	μS	-	-	0.3	I <sub>F</sub> =400A,V <sub>GE</sub> =-10V, di/dt=400A/μs
Thermal Impedance IGBT		Rth(j-c)	°C/W	-	-	0.085	Junction to case
	FWD	Rth(j-c)		-	-	0.22	

Notes:(4)  $R_G$  value is the test condition's value for decision of the switching times, not recommended value. Determine the suitable  $R_G$  value after the measurement of switching waveforms (overshoot voltage,etc.)with appliance mounted





## HITACHI POWER SEMICONDUCTORS

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